

Conference Agenda

Wednesday, August 26

Wednesday, August 26			
09:00 – 09:40	Conference Room 14B	Conference Opening & Award Ceremony Conference Director: Leo Lorenz, ECPE, DE	
09:40 – 10:20	Conference Room 14B	Keynote 1: Challenges and Innovations in Data Center Power Systems to Meet the AI Power Demand Speaker: Dehong Xu, Zhejiang University, CN	

Thursday, August 27

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09:30 – 10:10	Conference Room 14B	Keynote 2: Semiconductor contribution to performance & efficiency of Automotive Traction Inverters Speaker: Mark Nils Muenzer, Infineon Technologies AG, DE Chair: Gourab Majumdar, Mitsubishi Electric Corporation, JP	
10:10 – 10:25	Coffee Break & Room Change		
10:25 – 12:15	Conference Room 14B Special Session 2: AI in Power Electronics Chair: Jianing Wang, Hefei University of Technology, CN	Conference Room 14A Oral Session 3: Advanced Power Semiconductor Devices Technology Chair: Norbert Pluschke, CN-iCuTech Semiconductor, HKSAR, CN Yi Tang, Starpower Semiconductor, CN	
12:15 – 13:30	Lunch Break		
13:30 – 15:00	Poster Dialogue Session 4 High Performance Power Conversion Chair: Lie Xu, Tsinghua University, CN	Poster Dialogue Session 5 Motor Drive & Motion Control Chair: Jinsong Kang, Tongji University, CN Gaosheng Song, Mitsubishi Electric & Electronics (Shanghai) Co., Ltd.	Poster Dialogue Session 6 Automotive Power Electronics and Electrified Transportation Chair: Guoqiang Zhang, Harbin Institute of Technology, CN Gang Yao, Shanghai Maritime University, CN
15:00 – 16:50	Conference Room 14B Oral Session 4: AI in Power Electronics Chair: Jinjun Liu, Xi'an Jiaotong University, CN Lifeng Chen, Infineon Technologies, CN	Conference Room 14A Oral Session 5: Packaging and Reliability for Power Semiconductors Chair: Naoto Fujishima, Fuji Electric, JP Xuhui Wen, Institute of Electrical Engineering, Chinese Academy of Sciences, CN	

Friday, August 28

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09:00– 09:40	Conference Room 14B	Keynote 3: TBC Speaker: Junsheng Wei, BYD Company Limited, CN Chair: TBC	
09:40 – 10:20	Conference Room 14B	Keynote 4: Enabling the Medium-Voltage Revolution: Innovations in 10kV SiC Power Packaging Platforms Speaker: Ziyang Gao, Hong Kong Microelectronics Research and Development Institute, HKSAR, CN Chair: Dong Li, Infineon Technologies Asia Pacific Pte Ltd, SG	
10:20 – 10:35	Coffee Break & Room Change		
10:35 – 12:25	Conference Room 14B Oral Session 6: Motor Drives and Electrified Transportation Chair: Yongdong Li, Tsinghua University, CN Dapeng Zheng, Shenzhen Hopewind Electric, CN		Conference Room 14A Oral Session 7: Power Electronics for Smart Grid Chair: Meiqin Mao, Hefei University of Technology, CN Jianping Ying, Delta Electronics, CN
12:25 – 13:30	Lunch Break		
13:30 – 18:00	The PCIM Asia Shenzhen Tour *only by invitation, First in first served		